4. (Amended) A base body for a photosensitive drum according to claim 1, wherein said polyamide resin is one kind or two or more kinds selected from polyamide resins including polyamide 11, polyamide 12, polyamide 46, polyamide 6, polyamide 66, polyamide resin produced by polycondensation of metaxylylene diamine and adipic acid, polyamide 610, polyamide 612, polyamide 1212, and copolymers thereof.

6. (Amended) A base body for a photosensitive drum according to claim 1, wherein said conductive resin composition further comprises a compatibility enhancing agent for enhancing a compatibility between said polyamide resin and said low water absorption resin.

8. (Amended) A base body for a photosensitive drum, which is obtained by molding a conductive resin composition into a cylindrical shape,

said resin composition comprising a resin base material and a conductive agent,

wherein said conductive agent is carbon black having a dibutyl phthalate (DBP) oil absorption amount in a range of 130 ml/100g or more.

10. (Amended) A base body for a photosensitive drum according to claim 8, wherein said resin base material comprises a polyamide resin obtained from metaxylylene diamine and adipic acid and/or a polyamide resin obtained from ε-caprolactam.

11. (Amended) A base body for a photosensitive drum according to claim 8, wherein said conductive resin composition comprises an inorganic filler for reinforcement.

12. (Amended) A base body for a photosensitive drum, which is obtained by molding a conductive resin composition into a cylindrical shape,

said resin composition comprising an inorganic filler for reinforcement,

wherein said inorganic filler for reinforcement is at least one of a micro-spherical inorganic material and a flake-shaped inorganic material, and said micro-spherical inorganic material is in the form of spherical particles having an average particle size in a range of 50 μm or less.

19. (Amended) A base body for a photosensitive drum, which is obtained by molding a conductive resin composition into a cylindrical shape,

said resin composition comprising an inorganic filler for reinforcement,

wherein said inorganic filler for reinforcement is a fibrous inorganic material in the form of fibers each having a length ranging from 8 to 50 μm and a diameter ranging from 0.1 to 5 μm, and wherein said base body has a surface roughness such that a center line average height Ra is in a range of less than 0.2 μm and a maximum height Rmax is in a range of less than 0.8 μm.

23 (Amended) A base body for a photosensitive drum, which is obtained by molding a conductive resin composition into a cylindrical shape,

wherein said resin composition consists essentially of polyamide resin and has a factor tanδ expressing a frequency characteristic of said resin composition measured by an apparatus for measuring a complex modulus of elasticity, which factor is in a range of 0.05 or more.

24. (Amended) A base body for a photosensitive drum according to claim 23, wherein said conductive resin composition further comprises an inorganic filler for reinforcement.

25. (Amended) A photosensitive drum comprising:

a cylindrical base body, which is obtained by molding a conductive resin composition into a cylindrical shape; and

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a photosensitive layer formed on an outer peripheral surface of said cylindrical base body;

wherein said resin composition comprises a resin base material and a conductive agent, and said resin base material is a mixed resin of a polyamide resin and a low water absorption resin having a water absorption percentage in a range of 0.3% or less.

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28. (Amended) A photosensitive drum according to claim 25, wherein said polyamide resin is one kind or two or more kinds selected from polyamide resins including polyamide 11, polyamide 12, polyamide 46, polyamide 6, polyamide 66, polyamide resin produced by polycondensation of metaxylylene diamine and adipic acid, polyamide 610, polyamide 612, polyamide 1212, and copolymers thereof.

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30. (Amended) A photosensitive drum according to claim 25, wherein said conductive resin composition further comprises a compatibility enhancing agent for enhancing a compatibility between said polyamide resin and said low water absorption resin.

32. (Amended) A photosensitive drum comprising:

a cylindrical base body, which is obtained by molding a conductive resin composition into a cylindrical shape; and

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a photosensitive layer formed on an outer peripheral surface of said cylindrical base body;

wherein said resin composition comprises a resin base material and a conductive agent, and said conductive agent is carbon black having a dibutyl phthalate (DBP) oil absorption amount in a range of 130 ml/100g or more.

34. (Amended) A photosensitive drum according to claim 32, wherein said resin base material comprises a polyamide resin obtained from metaxylylene diamine and adipic acid and/or a polyamide resin obtained from ε-caprolactam.

35. (Amended) A photosensitive drum according to claim 32, wherein said conductive resin composition comprises an inorganic filler for reinforcement.

36. (Amended) A photosensitive drum comprising:

a cylindrical base body, which is obtained by molding a conductive resin composition into a cylindrical shape; and

a photosensitive layer formed on an outer peripheral surface of said cylindrical base body;

wherein said resin composition comprises an inorganic filler for reinforcement, and said inorganic filler for reinforcement is at least one of a micro-spherical inorganic material and a flake-shaped inorganic material, and wherein said micro-spherical inorganic material is in the form of spherical particles having an average particle size in a range of 50 μm or less.

43. (Amended) A photosensitive drum comprising:

a cylindrical base body, which is obtained by molding a conductive resin composition into a cylindrical shape; and

a photosensitive layer formed on an outer peripheral surface of said cylindrical base body;

wherein said resin composition comprises an inorganic filler for reinforcement, and said inorganic filler for reinforcement is a fibrous inorganic material in the form of fibers each having

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a length ranging from 8 to 50 μm and a diameter ranging from 0.1 to 5 μm, and wherein said base body has a surface roughness such that a center line average height Ra is in a range of less than 0.2 μm and a maximum height Rmax is in a range of less than 0.8 μm.

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47. (Amended) A photosensitive drum comprising:

a cylindrical base body, which is obtained by molding a conductive resin composition into a cylindrical shape; and

a photosensitive layer formed on said cylindrical base body;

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wherein said resin composition consists essentially of polyamide resin and has a factor tanδ expressing a frequency characteristic of said resin composition measured by an apparatus for measuring a complex modulus of elasticity, which factor is in a range of 0.05 or more.

48. (Amended) A photosensitive drum according to claim 47, wherein said conductive resin composition further comprises an inorganic filler for reinforcement.